

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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R₃BC

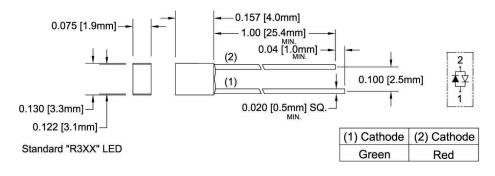
- Rectangular Package
- **RoHS Compliant**
- White Diffused Lens
- Available in Standard Lead Frame style
- 2-Lead Bi-Color LED
- Ideal for Status Indication and Bar Graph Displays
- Recommended for Bivar H-480C holder assemblies



Bivar Rectangular 2 x 3mm Package Bi-Color LED is ideal for those applications where dual signals need to be displayed at the same locations such as standby-on indication on server and computer peripherals. The rectangular package makes it ideal for creating bar graph displays when arranged in linear LED arrays. Bivar offers white diffused LED lens for uniform light output and the 2-lead package will simplify circuitry design where a reverse voltage is available. The Standard Lead frame LED is ideal for vertical spacer assemblies and Right Angle Holder assemblies that require lead bends.

Part Number	Material	Emitted Color	Peak. Wavelength λρ(nm) TYP.	Lens Appearance	Viewing Angle	
R3BC	GaAsP/GaP	RED	625nm	White Diffused	120°	
NJBC	GaP/GaP	GREEN	568nm	vville Dillused		

Outline Dimensions



Recommended Mounting Hole Size = $\emptyset.032^{+.003}_{-.002}$

- Outline Drawings Notes:

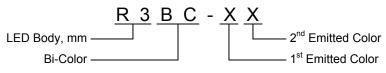
 1. All dimensions are in inches [millimeters].

 2. Standard tolerance: ±0.010" unless otherwise noted.

 3. Tolerance of overall epoxy outline: ±0.020" unless otherwise noted.

 4. Epoxy meniscus may extend to 0.060" max.

Part Number Designation











Absolute Maximum Ratings

 $T_A = 25^{\circ}C$ unless otherwise noted

Power Dissipation	80 mW
Forward Current (DC)	30 mA
Peak Forward Current ¹	150 mA
Reverse Voltage	5 V
Operating Temperature Range	-25 ~ +85°C
Storage Temperature Range	-30 ~ +100°C
Lead Soldering Temperature (3 mm from the base of the epoxy bulb) 2	260°C

Notes: 1. 10% Duty Cycle, Pulse Width ≤ 0.1 msec.

2. Solder time less than 5 seconds at temperature extreme.

Electrical / Optical Characteristics

 $T_A = 25^{\circ}C \& I_F = 20 \text{ mA}$ unless otherwise noted

Part Number	Emitted Color	Forward Voltage (V) ¹		Recommend Forward Current (mA)		Reverse Current (µA)	Dominant			Luminous Intensity Iv (mcd)			Viewing Angle 2 Θ ½ (deg)		
		MIN	TYP	MAX	MIN	TYP	MAX	MAX	MIN	TYP	MAX	MIN	TYP	MAX	TYP
R3BC	Red	/	2.0	2.8	,	20	/	100	/	1	1	/	3	1	120
KSBC	Green	/	2.1	2.8	/				/	1	/	/	2.5	1	

Notes: 1. Tolerance of forward voltage: ±0.05V.

2. Tolerance of dominant wavelength: ±1.0nm.



Typical Electrical / Optical Characteristics - Red

 $T_A = 25$ °C unless otherwise noted

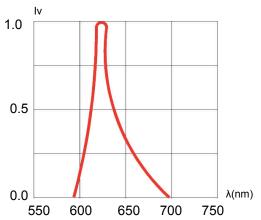


Fig. 1 Relative Luminous Intensity vs. Wavelength @ 20mA

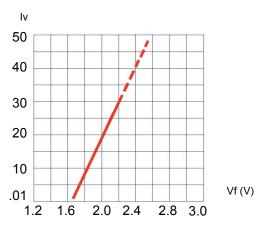


Fig. 3 Relative Intensity (10mA) vs. Forward Voltage

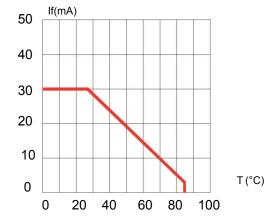


Fig. 5 Forward Current vs. Temperature

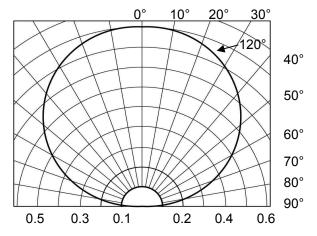


Fig. 2 Directivity Radiation Diagram

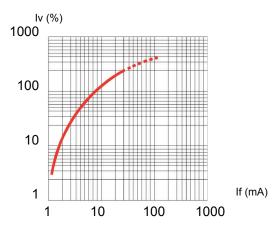


Fig. 4 Relative Luminous Intensity (%) vs. Forward Current

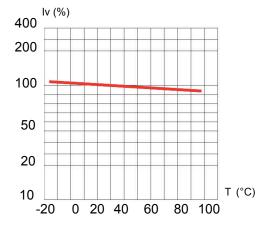


Fig. 6 Relative Intensity (%) vs. Temperature @ 20 mA



Typical Electrical / Optical Characteristics - Green

 $T_A = 25$ °C unless otherwise noted

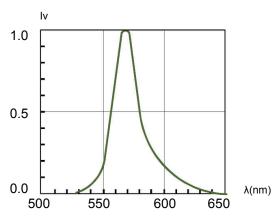


Fig. 1 Relative Luminous Intensity vs. Wavelength @ 20mA

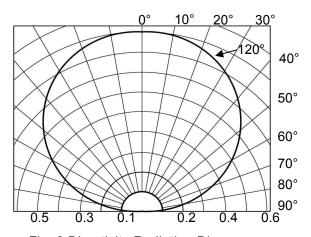


Fig. 2 Directivity Radiation Diagram

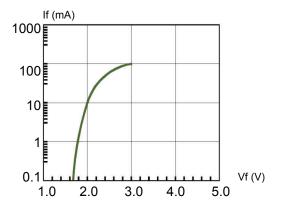


Fig. 3 Forward Current vs. Forward Voltage

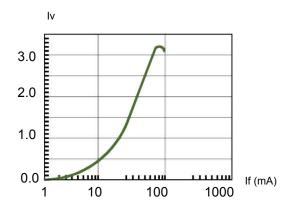


Fig. 4 Relative Luminous Intensity vs. Forward Current Normalize @ 20 mA

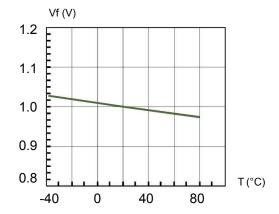


Fig. 5 Forward Voltage vs. Temperature

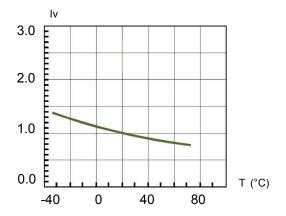
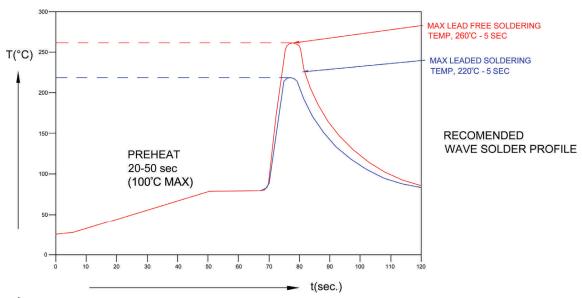


Fig. 6 Relative Luminous Intensity vs. Temperature

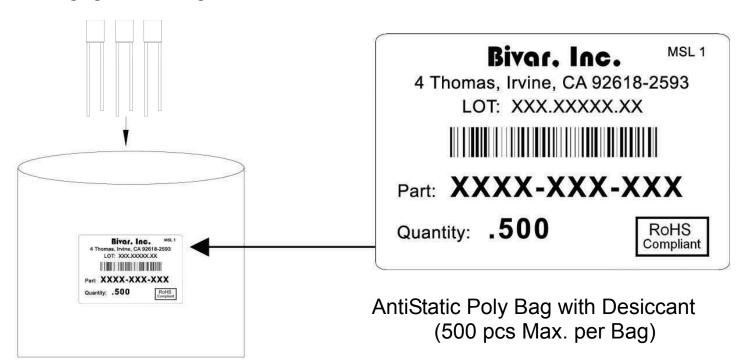


Recommended Soldering Conditions



Recommended Lead Free Wave Soldering Profile					
Preheat Temperature: 100°C Max.	Peak Temperature: 260°C Max.				
Preheat Time: 20 ~ 50 Seconds	Solder Time Above 217°C: 5 Seconds Max.				
Note: Turn off top heater at preheat to prevent the lamp body directly exposed to the heat source.					

Packaging and Labeling Plan



Bivar reserves the right to make changes at any time without notice